

# SMART DRAM Memory for Networking & Telecom

Reliable, Trusted, Proven



## Why DRAM Memory?

SMART's DRAM memory products for networking and telecom applications are built to withstand the extreme environments these settings demand.

They are put through a rigorous test process and can be specifically enhanced for protection from extreme temperatures, moisture, and exposure to severe environmental conditions, making them ideal for telecom field applications.

SMART's memory modules are offered in a variety of form factors and DRAM technologies. SMART provides long-term product support specifically aligned for networking and telecom applications

## Special features to support networking applications



100% high and low temperature testing



Conformal coating for moisture and environmental protection



Component underfill for vibration resistance



Anti-sulfur passive components for environmental protection

## VLP Mini-DIMM



- 8GB, 16GB
- I-temp option
- Very small form factor
- Ideal for NEBS compliance applications

## VLP RDIMM



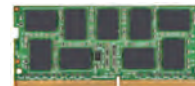
- 8GB to 32GB
- I-temp option
- Ideal for blade applications with height restrictions

## ULP ECC UDIMM



- 8GB to 32GB
- I-temp option
- Ideal for blade applications with height restrictions
- High density with 1-2 DIMM sockets

## ECC SO-DIMM



- 8GB to 32GB
- I-temp option
- Ideal for embedded system boards

## Contact information

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